OMB No 0651-0027 (exp 02/28/2009)	2/27/2010 DEPARTMENT OF COMMERCI States Patent and Trademark Office
	103614353
To the Director of the U.S. Patent and Trademar.	, the new address(es) below
Name of conveying party(ies):	2. Name and address of receiving party(ies)
Daisuke Iseki	Name Sony Corporation
À	
Additional name(s) of conveying party(ies) attached? Yes X No	Internal Address
	Street Address
3. Nature of conveyance/Execution Date(s):	1-7-1 Konan
Execution Date(s) November 26, 2010	Minato-Ku,
X Assignment Merger Change of Name	
Security Agreement Joint Research Agreement	City Tokyo
Government Interest Assignment	
Executive Order 9424, Confirmatory License	State
	Country JAPAN Zip 108-0075
Other	Additional name(s) & address(es) Yes X No
A Patent Application No (s) 29/347,987 Additional numbers attached?	This document is being filed together with a new application B Patent No (s) Yes X No
Name and address to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved:
Name RADER, FISHMAN & GRAUER PLLC	7. Total fee (37 CFR 1 21(h) & 3 41) \$ 40 00
Internal Address Atty Dkt SDE-2583 Street Address 1233 20th Street, N W Suite 501	X Authorized to be charged to deposit account Enclosed None required (government interest not affecting title)
City Washington	8. Payment Information
State DC Zip 20036	
Phone Number (202) 955-3750	
Fax Number (202) 955-3751	Deposit Account Number18-0013
Email Address	Authorized User Name Sterling D. Fillmore
9. Signature:	
1000	December 21, 2010
Signature	Date
Sterling D. Fillmore - 63,796	Total number of pages including cover sheet attachments and documents
Name of Person Signing	sheet, attachments, and documents

12/27/2010 HTON11 00000065 180913 29347987

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Docket Number: SDE-2583

ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in

MICROPHONE FOR HEADSET

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, SONY CORPORATION, a Japanese corporation with offices at 1-7-1 Konan, Minato-ku, Tokyo, 108-0075 JAPAN, (hereinafter referenced as ASSIGNEES) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of Ten Dollar (\$10.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEES, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEES, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEES or its designee, as ASSIGNEES or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

PATENT REEL: 025663 FRAME: 0243

Attorney Docket No. SDE-2583

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEES will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow:

Serial Number: 29/347,987, Filing Date: 09/03/2010.

This assignment executed on the dates indicated below.

Daisuke Deckl November 26, 200

Signature Date Daisuke ISEKI

PATENT REEL: 025663 FRAME: 0244

RECORDED: 12/21/2010